

QUICKSWITCH® PRODUCTS 2.5V / 3.3V 32:16 MUX/DEMUX HIGH BANDWIDTH BUS SWITCH

IDTQS3VH16233

FEATURES:

- N channel FET switches with no parasitic diode to Vcc
 - Isolation under power-off conditions
 - No DC path to Vcc or GND
 - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Low Ron 4Ω typical
- · Flat Ron characteristics over operating range
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- Excellent Ron matching between channels
- · Vcc operation: 2.3V to 3.6V
- · High bandwidth up to 500 MHz
- · LVTTL-compatible control Inputs
- · Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 4pF typical
- · Available in TSSOP package

APPLICATIONS:

- · Hot-swapping
- 10/100 Base-T, Ethernet LAN switch
- · Low distortion analog switch
- · Replaces mechanical relay
- ATM 25/155 switching

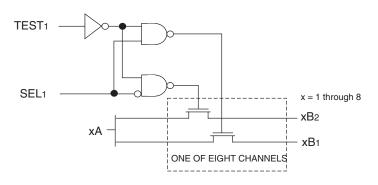
DESCRIPTION:

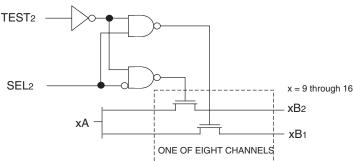
The QS3VH16233 HotSwitch is a 32-bit to 16-bit high bandwidth bus switch, which can multiplex or demultiplex data. The QS3VH16233 has very low ON resistance, resulting in under 250ps propagation delay through the switch. This device can be used as two 16-bit to 8-bit multiplexers or as one 32-bit to 16-bit multiplexer. SELx inputs control the data flow. TESTx inputs control either one or two ports connection. In the OFF and ON states, the switches are 5V-tolerant. In the OFF state, the switches offer very high impedance at the terminals.

The combination of near-zero propagation delay, high OFF impedance, and over-voltage tolerance also makes the QS3VH16233 ideal for high performance communications applications.

The QS3VH16233 is characterized for operation from -40°C to +85°C.

FUNCTIONAL BLOCK DIAGRAM

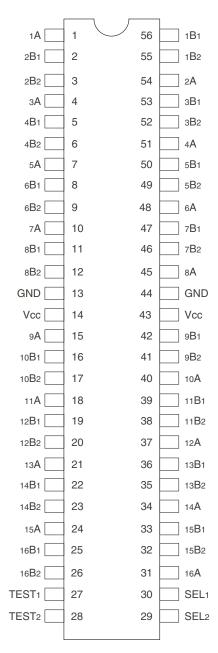




INDUSTRIAL TEMPERATURE RANGE

FEBRUARY 2013

PIN CONFIGURATION



TSSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max.	Unit
VTERM(2)	Supply Voltage to Ground	-0.5 to 4.6	V
VTERM(3)	DC Switch Voltage Vs	- 0.5 to 5.5	V
VTERM(3)	DC Input Voltage VIN	- 0.5 to 5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V
lout	DC Output Current (max. current/pin)	120	mA
Tstg	Storage Temperature	-65 to +150	°C

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may
 cause permanent damage to the device. This is a stress rating only and functional
 operation of the device at these or any other conditions above those indicated in the
 operational sections of this specification is not implied. Exposure to absolute
 maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. All terminals except Vcc.

CAPACITANCE (TA = +25°C, f = 1MHz, VIN = 0V, VOUT = 0V)

Symbol	Parameter ⁽¹⁾	Тур.	Max.	Unit	
CIN	Control Inputs		3	5	pF
CI/O	Quickswitch Channels	Mux	8	12	pF
	(Switch OFF)	Demux	4	6	
CI/O	Quickswitch Channels	Mux	16	24	pF
	(Switch ON)	Demux	8	12	

NOTE:

1. This parameter is guaranteed but not production tested.

PIN DESCRIPTION

Pin Names	I/O	Description
хA	I/O	Bus A
xBx	I/O	Bus B
SELx	I	Data Select
TESTx	I	Port Select

FUNCTION TABLE(1)

SELx	TESTx	хA	Function
L	L	xB1	xA to xB1
Н	L	xB2	xA to xB2
Х	Н	xB1, xB2	xA to xB1 and xB2

NOTE

- 1. H = HIGH Voltage Level
- L = LOW Voltage Level
- X = Don't Care

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE(1)

 $Following\ Conditions\ Apply\ Unless\ Otherwise\ Specified:$

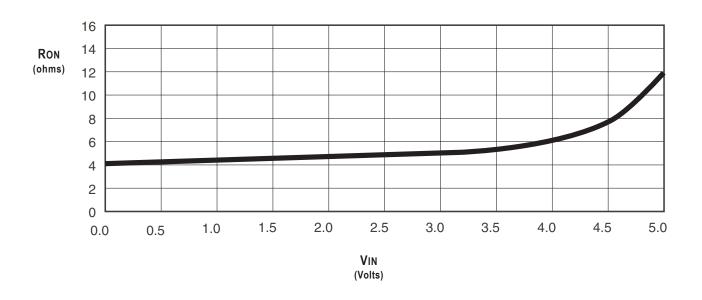
Industrial: TA = -40°C to +85°C, Vcc = 3.3V ± 0.3 V

Symbol	Parameter	Test Conditions			Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage	Guaranteed Logic HI	GH	Vcc = 2.3V to 2.7V	1.7	_	_	V
		for Control Inputs		Vcc = 2.7V to 3.6V	2	_	_	
VIL	Input LOW Voltage	Guaranteed Logic HI	GH	Vcc = 2.3V to 2.7V	_	_	0.7	V
		for Control Inputs		Vcc = 2.7V to 3.6V	_	_	0.8	
lin	Input Leakage Current (Control Inputs)	0V ≤ VIN ≤ VCC		_	_	±1	μA	
loz	Off-State Current (Hi-Z)	0V ≤ Vouт ≤ 5V, Switches OFF		_	_	±1	μA	
loff	Data Input/Output Power Off Leakage	VIN or VOUT 0V to 5V, VCC = 0V		_	_	±1	μA	
		Vcc = 2.3V	VIN = 0V	Ion = 30mA	_	6	8	
Ron	Switch ON Resistance	(Typ. at Vcc = 2.5V)	VIN = 1.7V	ION = 15mA	_	7	9	Ω
		Vcc = 3V	VIN = 0V	Ion = 30mA	_	4	6	
			VIN = 2.4V	ION = 15mA	_	5	8	

NOTE:

1. Typical values are at Vcc = 3.3V and TA = 25°C, unless otherwise noted.

TYPICAL ON RESISTANCE vs Vin AT Vcc = 3.3V



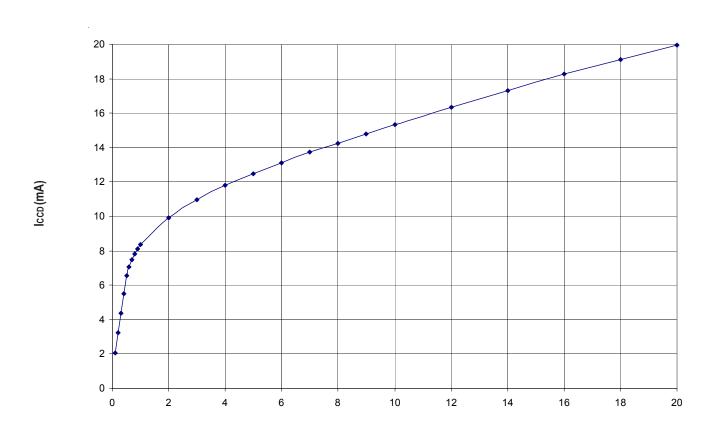
POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾	Min.	Тур.	Max.	Unit
Iccq	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc, f = 0	_	1.5	3	mA
Δlcc	Power Supply Current ^(2,3) per Input HIGH	Vcc = Max., Vin = 3V, f = 0 per Control Input	_	_	30	μA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = 3.3V, A and B Pins Open, Control Inputs	See Typical	ICCD vs Enable	Frequency gra	ph below
		Toggling @ 50% Duty Cycle				

NOTES:

- 1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
- 2. Per input driven at the specified level. A and B pins do not contribute to Δ lcc.
- 3. This parameter is guaranteed but not tested.
- 4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT Vcc = 3.3V



ENABLE FREQUENCY (MHz)

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

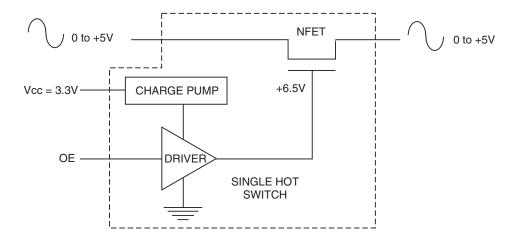
 $T_A = -40$ °C to +85°C

		$Vcc = 2.5 \pm 0.2V^{(1)}$		$Vcc = 3.3 \pm 0.3 V^{(1)}$			
Symbol	Parameter	Min. ⁽⁴⁾	Max.	Min. ⁽⁴⁾	Max.	Unit	
tPLH	Data Propagation Delay ^(2,3)	_	0.2	_	0.2	ns	
t PHL	A to B or B to A						
t BX	Switch Multiplex Delay	1.5	9	1.5	7.5	ns	
	SEL to xA						
t PZH	Switch Turn-On Delay	1.5	9	1.5	8	ns	
t PZL	SEL to xBx						
tPHZ	Switch Turn-Off Delay	1.5	7.5	1.5	7.5	ns	
tPLZ	SEL to xBx						
tpzH	Switch Turn-On Delay	1.5	8.5	1.5	9	ns	
t PZL	TEST to xBx						
tpHZ	Switch Turn-Off Delay	1.5	8.5	1.5	8.5	ns	
tPLZ	TEST to xBx						
fsx	Operating Frequency - Enable (2,5)	_	7.5	_	15	MHz	

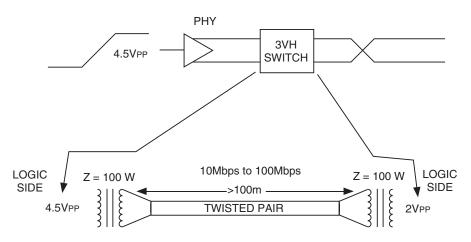
NOTES:

- 1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.
- 2. This parameter is guaranteed but not production tested.
- 3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.2ns at C_L = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
- 4. Minimums are guaranteed but not production tested.
- 5. Maximum toggle frequency for Sx control input (pass voltage > Vcc, Vin = 5V, RLOAD \geq 1M Ω , no CLOAD).

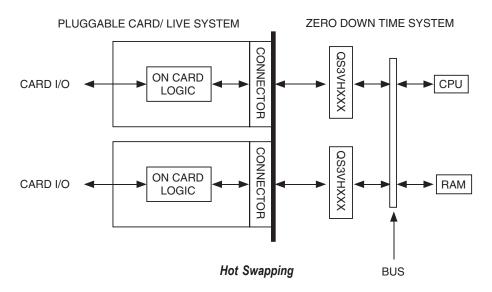
SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching



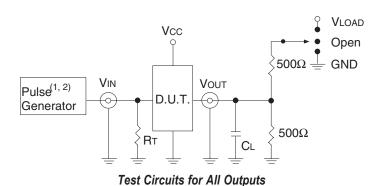
Fast Ethernet Data Switching (LAN Switch)



TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	Vcc ⁽¹⁾ = 3.3V ± 0.3V	Vcc ⁽²⁾ = 2.5V ± 0.2V	Unit
VLOAD	6	2 x Vcc	V
VIH	3	Vcc	V
VT	1.5	Vcc/2	V
VLZ	300	150	mV
VHZ	300	150	mV
CL	50	30	pF



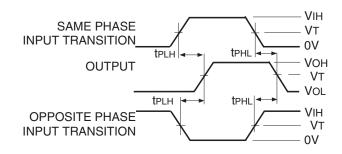
DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

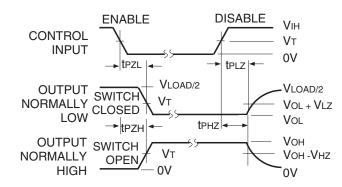
RT = Termination resistance: should be equal to ZouT of the Pulse Generator.

NOTES:

- 1. Pulse Generator for All Pulses: Rate \leq 1.0MHz: tF \leq 2.5ns: tR \leq 2.5ns.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2ns; tR \leq 2ns.



Propagation Delay



NOTE:

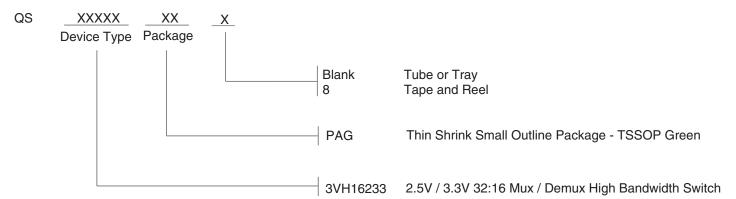
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Enable and Disable Times

SWITCH POSITION

Test	Switch
tplz/tpzl	VLOAD
tphz/tpzh	GND
tpp	Open

ORDERING INFORMATION



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